Giant tunneling magnetoresistance with electron beam evaporated MgO barrier and CoFeB electrodes

H. Kurt, a K. Oguz, T. Niizeki, b and J. M. D. Coey
CRANN and School of Physics, Trinity College Dublin, Dublin 2, Ireland

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Electron-beam (EB) evaporated MgO grows with (001) texture on amorphous CoFeB when the deposition rate is kept below 5 pm/s. Magnetic tunnel junctions (MTJs) fabricated using this method exhibit ~240% magnetoresistance at room temperature for a 2.5 nm thick EB-MgO barrier, which is similar to the value for a radio frequency (rf) sputtered barrier with the same junction geometry. The average barrier height of the EB-MgO is 0.48 eV, which is higher than previously reported values for rf-MgO barriers and it increases with increasing annealing temperature. Our results show that EB-MgO could be a simpler alternative to rf-MgO in MTJs without any compromise in the tunnelling magnetoresistance. © 2010 American Institute of Physics. [doi:10.1063/1.3371811]

I. INTRODUCTION

Spin dependent tunnelling through a crystalline MgO (001) barrier has intrigued researchers worldwide due to its potential for rich physics and device applications. Following theoretical predictions, 1,2 room temperature tunnelling magnetoresistance (TMR) ratios above 200% were reported in magnetic tunnel junctions (MTJs) with highly oriented MgO (001) tunnel barriers. 3,4 Coherent crystalline growth of a bcc ferromagnet (001)/MgO (001)/bcc ferromagnet (001) MTJ structure gives rise to coherent tunnelling, which in turn leads to high TMR ratios due to the selective tunnelling of electrons with Δ1 symmetry through the MgO barrier. 1,2 Such MTJs form the basis of the new generation of read head sensors, high speed nonvolatile magnetic memories such as spin torque magnetic random access memory, and spin transfer torque (STT) nano-oscillator microwave sources. 5 The MgO (001) tunnel barriers are usually grown by radio frequency (rf) sputtering or molecular beam epitaxy (MBE) in high or ultrahigh vacuum (UHV) with very low H2O partial pressure due to hygroscopic nature of MgO. We show here that high quality MgO barrier layers can also be grown by electron beam (EB) evaporation on top of amorphous CoFeB.

Growth and postannealing optimization using boron-doped CoFe amorphous electrodes has resulted in record TMR values in excess of 600% at room temperature in devices with no exchange bias layer and almost atomically flat interfaces, by suppression of diffusion of Ta from underlayer. 6 Sufficiently smooth interfaces are crucial to get high TMR ratios and they can most easily be obtained by growing MgO on amorphous CoFeB or NiFeB and postannealing the MTJ stack above 350 °C to crystallize bcc CoFe or NiFe using the MgO (001) barrier as a template. 7,8 During annealing, boron diffuses away to permit crystallization of bcc CoFe or NiFe through a 45° in-plane rotation toward (110) direction on MgO (001) to form an epitaxial structure at the interface. Achieving high TMR values also depends on the quality of the crystallinity of MgO as well as bcc ferromagnetic electrodes. In most MTJ stacks, the bottom CoFeB is pinned using a bottom pinned synthetic antiferromagnet (SAF) and a Ta layer is deposited adjacent to top CoFeB layer as a boron absorber. However, during annealing Mn, Ru, Ta, and B can diffuse into MgO barrier, which degrades the MgO quality and reduces TMR. 9 Recently obtained electron-energy-loss spectroscopy data have found B in the MgO barriers fabricated using B-doped amorphous ferromagnetic electrodes in addition to B inclusions in the adjacent Ta layers. 10 Despite the significant levels of B diffusion in rf-MgO, high TMR values were preserved in the low resistance×area (RA) regime of MTJs.

A simpler alternative to MBE or rf sputtering is to grow high quality MgO (001) barriers by EB evaporation. Such EB-MgO (001) layers have been grown earlier 11,12 but high TMR ratios with EB-MgO barrier deposited on B-doped electrodes have not been demonstrated. Here, we show that MTJs fabricated using EB-MgO can exhibit ~240% TMR at room temperature, which is comparable to that of rf-MgO MTJs, fabricated using the same stacks.

II. SAMPLES

Our sample geometry consists of Ta(5)/Ru(30)/Ta(5)/Ni80Fe20(5)/Ir22Mn78(10)/Co90Fe10(2.5)/Ru(0.9)/Co49Fe51B20(3)/MgO(t)/Co90Fe10B20(3)/Ta(5)/Ru(10) (all thicknesses in nm) with t=1.2, 1.5, 2, and 2.5 nm [see inset in Fig. 1(a)]. The MTJ stacks were deposited on 100 nm thermally oxidized Si wafers in a cluster deposition system based on a Shamrock sputtering tool. All metallic layers were dc-magnetron sputtered at room temperature using 9N purity argon from a heated purifier fed with 6N purity argon. The bottom and top electrodes were deposited in a high vacuum (HV) chamber with a base pressure of 1 ×10−7 Torr. After the deposition of bottom electrodes, without breaking the vacuum, the wafer is transferred to the UHV chamber with a base pressure of 2.1 ×10−10 Torr to deposit the active part of the MTJ stack (CoFeB/EB-MgO/CoFeB). A Telemark UHV linear e-beam source with circular beam area

a Electronic mail: kurt@tcd.ie.
b Present address: National Institute for Materials Science, 1-2-1 Sengen, Tsukuba, Ibaraki 305-0047, Japan.
sweep was used to deposit MgO. Then, the wafer is transferred back to the HV chamber to complete the stack. The active part of the rf-MgO MTJs was grown in another HV chamber of the Shamrock Cluster with a base pressure of $10^{-8}$ Torr, where the rf-MgO was grown using a target-facing-target sputter gun and 9N purity Ar. In both cases, 4N purity sintered MgO sources were used. A bottom synthetic antiferromagnet (SAF) is used to pin the magnetization of the bottom CoFeB while the magnetization of the top CoFeB is free to rotate.

The quality of MgO (001) grown on CoFeB using EB evaporation is highly dependent on the deposition rate. We have found that a rate lower than ~5 pm/s is necessary to crystallize MgO with (001) out of plane texture at room temperature. Higher rates result in amorphous MgO. We used ~3 pm/s deposition rate for the EB-MgO layers in the present study. The chamber pressure during MgO evaporation was 2–4 $\times$ 10^{-5}$ Torr. Micron-sized junctions were fabricated using standard photolithography and argon ion milling techniques. Postannealing of samples was performed in HV (3–4 $\times$ 10^{-6} Torr) in an in-plane magnetic field of 0.8 T for 1 h to crystallize CoFeB layers and to pin the bottom SAF structure. Magnetotransport measurements were made at room temperature using the conventional four-terminal method.

III. RESULTS AND DISCUSSION

Figure 1(a) shows typical room temperature and 25 K magnetoresistance curves for a 2.5 nm thick EB-MgO MTJ, postannealed at 400 °C. TMR ratios in excess of 240% at room temperature and 312% at 25 K were obtained for EB-MgO MTJs, which are comparable to those of rf-MgO MTJs. A cross-sectional high-resolution transmission electron microscopy (HR-TEM) image of an as-deposited EB-MgO MTJ is shown in Fig. 1(b) revealing the highly crystalline structure of our EB-MgO barrier. The CoFeB electrodes are found to be amorphous as expected. After annealing at 400 °C, the CoFeB electrodes are also crystallized as seen in the transmission electron microscopy (TEM) micrograph in Fig. 1(c).

To compare the crystal structure of rf versus EB-MgO samples, we fabricated CoFeB(60)/MgO(10)/CoFeB(20) structures and postannealed them at 400 °C for 1 h. Figure 2 shows 2θ x-ray diffraction (XRD) scans of these 10 nm thick MgO samples obtained using Cu $K\alpha$ radiation. In the as-grown state, EB-MgO has a d-spacing that is almost exactly the same as that of bulk MgO ($a_0=4.211$ Å), whereas the rf-MgO shows a slight increase in the d-spacing. Upon annealing, both MgO layers have improved crystalline structures, revealed by the identical full width at half maximum values in the 2θ scans [Fig. 2(b)]. The decrease in the d-spacing of the rf-MgO is 1.07 p.m., whereas the decrease in the d-spacing of the EB-MgO is 0.92 pm after annealing. Upon annealing, EB-MgO has the same d-spacing as bulk MgO but the rf-MgO remains at a higher d-spacing as shown in Fig. 2(b). This could be due to different characteristics of the defect and impurity distributions in both samples. To compare the initial growth of EB-MgO with that of rf-MgO, we attempted to grow it on amorphous thermal SiOx. Our EB-MgO would never crystallize on top of SiOx unlike rf-MgO.
MgO, which is known to grow with (001) out of plane texture after forming few nanometer of amorphous MgO. This indicates that the initial growth characteristics of EB-MgO are different from those of conventional rf-MgO.

Figure 3 summarizes the TMR ratio versus annealing temperature of both EB and rf-MgO MTJs. In the as-grown state, all samples show low TMR values (~10%) due to incoherent tunneling. Upon annealing, B diffuses away and a coherent epitaxial structure, confirmed by HR-TEM, is created giving rise to coherent tunneling and high TMR values. In our samples, we observe an increase in the TMR value in both kinds of samples up to an annealing temperature of 425 °C. The highest TMR (~240%) for the EB-MgO samples was observed for the MTJ with a 2.5 nm barrier. TMR values gradually decrease as the EB-MgO thickness is reduced. An MTJ with 1.2 nm EB-MgO barrier showed a TMR of ~120% with an RA of 100 Ω μm². The exchange bias falls dramatically on annealing above 400 °C (see Fig. 4) due to significant loss of Mn from the antiferromagnetic IrMn layer. The higher temperature stability of the antiparallel (AP) state and therefore the high TMR in our MTJs is due to the thicker Ru layer in SAF structure, which serves as a barrier for Mn diffusion into MgO barrier. In the case of 450 °C annealing, the exchange bias is almost annihilated and a stable AP configuration is not achieved as shown in Fig. 4(d). We believe the reason for the drop in TMR ratios for the samples annealed at this temperature is mainly due to the lack of a stable AP state.

Figure 5 shows the RA product of EB versus rf-MgO MTJs for both parallel (P) and AP configurations. Both EB-MgO (closed symbols) and rf-MgO (open symbols) samples show an exponential increase in the RA values with increasing MgO barrier thickness, t_MgO. The error bars are smaller than the symbols. The lines are fits to the data for t_MgO ≥ 1.5 nm.
ing MgO thickness. Straight lines are drawn as guides to the eye to show the exponential increase. The deviations from this line in the low RA regime are common due to the highly pronounced effect of the interfacial roughness for thin barriers. Barrier heights of 0.47 eV for P and 0.49 eV for AP states were calculated from linear fits to the data points for \( t_{\text{MgO}} \geq 1.5 \) nm using Wenzel–Kramer–Brillouin (WKB) approximation in the low voltage limit.\(^{14}\) These values are higher than previously reported values for the rf-MgO (0.34–0.38 eV)\(^{15}\) and MBE grown MgO (0.39 eV)\(^{4}\) barriers, but much smaller than that for an ideal MgO tunnel barrier (3.7 eV).\(^{16}\) Significant deviations in the barrier heights of the MgO in MTJs from that of an ideal MgO could be attributed to the oxygen vacancies in the grown barriers.\(^{4}\) The greater barrier height of the EB-MgO barrier is most likely due to the lower defect densities compared to the rf-MgO, which reveals itself in the 2\( \theta \) XRD scans as shown in Fig. 2. A greater barrier height could be advantageous for sensor and STT applications, where a higher voltage output is required. In addition, the EB-MgO barrier may exhibit lower noise levels on account of the low defect density.

The relevant TMR value for STT switching is the value at the switching current (voltage) which is typically about half of the maximum TMR. We determined the bias dependencies of our samples using the I-V plots in P and AP states and they are plotted in Fig. 6. The rf-MgO MTJ shows an almost symmetric decrease of TMR as a function of bias but the EB-MgO MTJ shows an asymmetric behavior. For negative bias (electrons tunnelling from free to pinned layer), the TMR of the EB-MgO sample decreases at a lower rate than that for the positive bias, whereas the rate of drop in TMR of rf-MgO sample as a function of bias is faster but almost same for both polarities. For electrons tunnelling from the free layer to the pinned layer, the tunnelling probability is lower at the same bias, therefore the negative bias needs more energy for field emission tunnelling, which is due to the asymmetric nature of top and bottom interfaces of the EB-MgO. This asymmetry could be explained by the differences in the initial growth characteristics of rf versus EB-MgO. In rf sputtering, the sputtered species are more energetic than those for the EB evaporated ones. Our attempts to grow EB-MgO on thermal SiO\(_x\) did not result in a crystalline MgO, whereas it is known that the rf-MgO can be grown with (001) out of plane texture on SiO\(_x\). The top MgO/CoFeB interfaces are almost the same for both samples; the I-V curves show similar bias dependence at positive voltage. The same asymmetric bias dependence of TMR is also observed at 25 K for the EB-MgO sample, however, the rate of drop in TMR is higher at low temperatures.

Differential conductance measurements of both types of samples display different behavior for coherent transport in the P state as shown in Figs. 7(a) and 7(c). For electrons tunnelling from free to pinned layer (negative bias), the differential conductance minimum is higher than those for electrons tunnelling in the reverse direction for the EB-MgO MTJ, and vice-versa for the rf-MgO MTJ. The asymmetry of coherent tunneling at the interfaces in the P state is more pronounced in the rf-MgO MTJ sample, which corroborates the argument about the different initial growth characteristics for different MgO growth methods.
Figure 8 shows the variation in resistance with annealing temperature of both EB- and rf-MgO samples up to 425 °C. For the rf-MgO samples the resistance has a tendency to decrease with increasing annealing temperature, whereas for the EB-MgO samples the resistance has a tendency to increase in both P and AP states. This is probably due to structural differences in these MgO barriers. The increase in the resistances of EB-MgO samples indicates that the barrier height increases with increasing annealing temperature. However, for the rf-MgO case, as the annealing temperature is increased, the insulating property of the rf-MgO deteriorates despite improved crystallinity, which may be attributed to increasing levels of impurities, such as B, Mn, or Ta diffusing into the rf-MgO barrier. This shows EB-MgO is more resistant to diffusion during postannealing.

IV. CONCLUSIONS

We have achieved TMR ratios in excess of 240% at room temperature and 312% at 25 K using EB-MgO barriers grown on amorphous CoFeB electrodes. The (001) texture is obtained by controlling the MgO deposition rate below 5 pm/s. The average calculated barrier height of our EB-MgO is higher than those for previously reported values of rf-MgO with similar TMR ratios, which is thought to be due to a lower defect density in the EB-MgO barrier. This could be advantageous for STT oscillator applications that require high voltage outputs as well as for sensor applications which require a lower low-frequency noise. The asymmetric behavior of the TMR drop as a function of bias for the EB-MgO reveals the asymmetry of the top and bottom interfaces, whereas the rf-MgO barrier has a more symmetric structure.

Structural differences in the MgO layers are revealed by 2θ scans performed on the thick EB and rf-MgO. It was found that the EB-MgO has a d-spacing that matches that of bulk MgO, whereas the rf-MgO shows a slight increase in the d-spacing, which could be attributed to a higher density of oxygen vacancies created during rf sputtering. Further studies are needed to understand the cause of the differences in the d-spacings of both samples. Increases in the resistance...
of EB samples and the decreases in resistance of rf samples with increasing annealing temperature could be due to a more diffusion resistant nature of EB-MgO.

Regardless of differences in their structures, initial growth, and annealing temperature behaviors, the TMR ratios achieved using EB-MgO barriers are comparable to those of our rf-MgO MTJs as well as those of several other groups. EB-MgO presents a simpler alternative to rf-MgO, which can be implemented at the wafer scale.

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